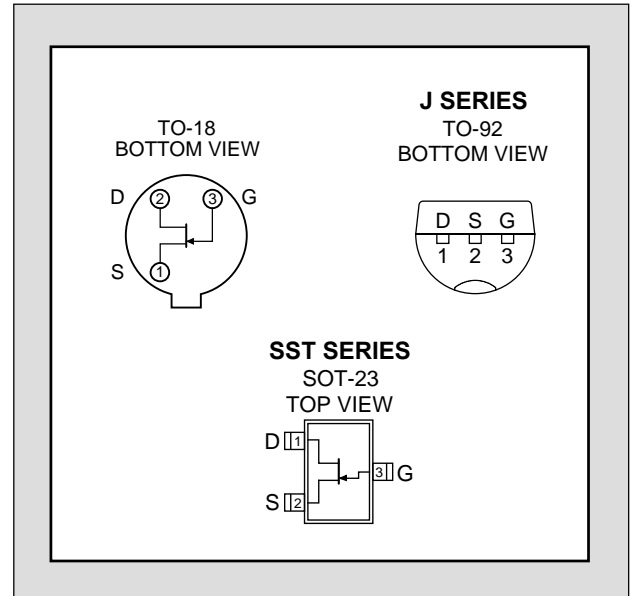


U/J/SST308 SERIES SINGLE N-CANNEL HIGH FREQUENCY JFET

FEATURES	
Direct Replacement For SILICONIX U/J/SST308 SERIES	
OUTSTANDING HIGH FREQUENCY GAIN	$G_{pg} = 11.5\text{dB}$
LOW HIGH FREQUENCY NOISE	$NF = 2.7\text{dB}$
ABSOLUTE MAXIMUM RATINGS ¹	
@ 25 °C (unless otherwise stated)	
Maximum Temperatures	
Storage Temperature	-55 to 150°C
Junction Operating Temperature	-55 to 135°C
Maximum Power Dissipation	
Continuous Power Dissipation (J/SST)	350mW
Continuous Power Dissipation (U)	500mW
Maximum Currents	
Gate Current (J/SST)	10mA
Gate Current (U)	20mA
Maximum Voltages	
Gate to Drain	-25V
Gate to Source	-25V



COMMON ELECTRICAL CHARACTERISTICS @ 25 °C (unless otherwise stated)

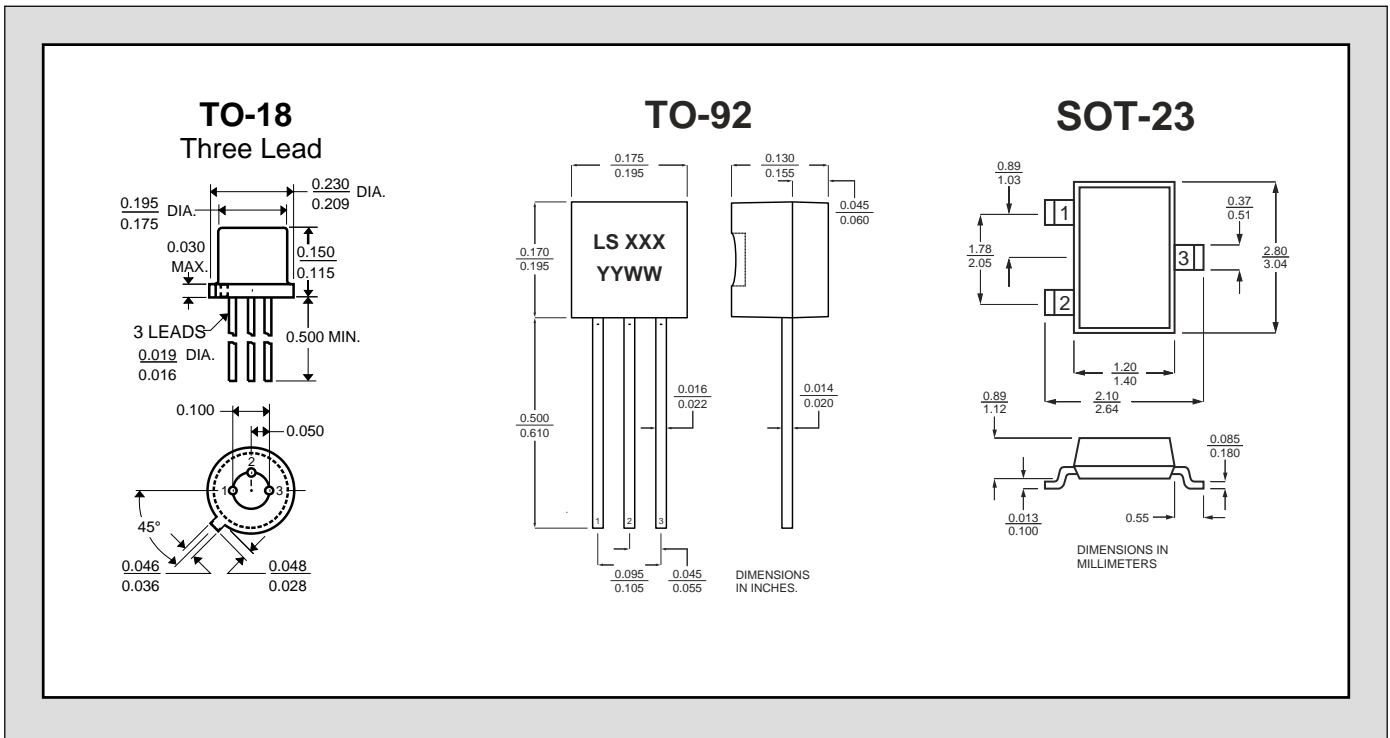
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNIT	CONDITIONS
BV_{GSS}	Gate to Source Breakdown Voltage	-25			V	$I_G = -1\mu\text{A}, V_{DS} = 0\text{V}$
$V_{GS(F)}$	Gate to Source Forward Voltage	0.7		1		$I_G = 10\text{mA}, V_{DS} = 0\text{V}$
I_G	Gate Operating Current		-15		pA	$V_{DG} = 9\text{V}, I_D = 10\text{mA}$
$r_{DS(on)}$	Drain to Source On Resistance		35		Ω	$V_{GS} = 0\text{V}, I_D = 1\text{mA}$
e_n	Equivalent Noise Voltage	6			nV/ $\sqrt{\text{Hz}}$	$V_{DS} = 10\text{V}, I_D = 10\text{mA}, f = 100\text{Hz}$
NF	Noise Figure	$f = 105\text{MHz}$	1.5		dB	$V_{DS} = 10\text{V}, I_D = 10\text{mA}$
		$f = 450\text{MHz}$	2.7			
G_{pg}	Power Gain ²	$f = 105\text{MHz}$	16			
		$f = 450\text{MHz}$	11.5			
g_{fg}	Forward Transconductance	$f = 105\text{MHz}$	14		mS	
		$f = 450\text{MHz}$	13			
g_{og}	Output Conductance	$f = 105\text{MHz}$	0.16			
		$f = 450\text{MHz}$	0.55			

SPECIFIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC	TYP	J/SST308		J/SST309		J/SST310		UNIT	CONDITIONS
			MIN	MAX	MIN	MAX	MIN	MAX		
V _{GS(off)}	Gate to Source Cutoff Voltage		-1	-6.5	-1	-4	-2	-6.5	V	V _{DS} = 10V, I _D = 1nA
I _{DSS}	Source to Drain Saturation Current ³		12	60	12	30	24	60	mA	V _{DS} = 10V, V _{GS} = 0V
C _{iss}	Input Capacitance	4		5		5		5	pF	V _{DS} = 10V, V _{GS} = -10V f = 1MHz
C _{rss}	Reverse Transfer Capacitance	1.9		2.5		2.5		2.5		
g _{fs}	Forward Transconductance	14	8		10		8		mS	V _{DS} = 10V, I _D = 10mA f = 1kHz
g _{os}	Output Conductance	110		250		250		250	μS	

SPECIFIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC	TYP	U308		U309		U310		UNIT	CONDITIONS
			MIN	MAX	MIN	MAX	MIN	MAX		
V _{GS(off)}	Gate to Source Cutoff Voltage		-1	-6.5	-1	-4	-2.5	-6.5	V	V _{DS} = 10V, I _D = 1nA
I _{DSS}	Source to Drain Saturation Current ³		12	60	12	30	24	60	mA	V _{DS} = 10V, V _{GS} = 0V
C _{iss}	Input Capacitance	4		5		5		5	pF	V _{DS} = 10V, V _{GS} = -10V f = 1MHz
C _{rss}	Reverse Transfer Capacitance	1.9		2.5		2.5		2.5		
g _{fs}	Forward Transconductance	14	10		10		10		mS	V _{DS} = 10V, I _D = 10mA f = 1kHz
g _{os}	Output Conductance	110		250		250		250	μS	



1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
2. Measured at optimum input noise match.
3. Pulse test: PW ≤ 300μs, Duty Cycle ≤ 3%

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